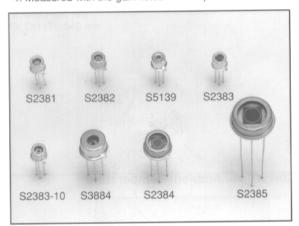
Si APDs (Low-bias Operation Types, for 800 nm Range)

Type No.	Dimensional Outline (P.46, 47)/ Window	Package	Effective *3 Active Area Size	Effective Active Area	Spectral Response Range λ	Peak *4 Sensitivity Wavelength λp	Photo Sensitivity M=1 λ=800 nm (A/W)	Quantum Efficiency M=1 λ=800 nm
	Material *1		(mm)	(mm ²)	(nm)	(nm)		(%)
S2381	0.07		φ0.2	0.03	400 to 1000		0.5	75
S2382	8 /K	TO-18	φ0.5 φ1.0	0.19				
S5139	9 /L					800		
S2383	8 /K			0.78				
S2383-10 *2	6 /K		ψσ	0.70				
S3884	® /K	TO-5	φ1.5	1.77				
S2384	1 /K	10-5	ф3.0	7.0				
S2385	® /K	TO-8	φ5.0	19.6	Types with suffix (

^{*1.} Window material K: borosilicarte glass L: lens type borosilicarte glass

^{*4:} Measured with the gain listed in this specification table



Types with suffix (-01: breakdown voltage 80 to 120 V, -02: 120 to 160 V, -03: 160 to 200 V) are available about S2381, S2382, S2383, and S3884.

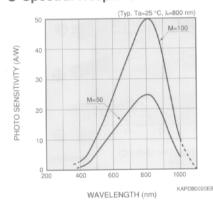
TE-cooled Si APDs

Parameter	S4315	S4315-01	S4315-02	Unit
APD	S2381	S2382	S2383	-
Effective Active Area ^{*3}	φ0.2	φ0.5	φ1.0	mm
Spectral Response Range		nm		
Peak Sensitivity Wavelength ¹⁴			nm	
Cooling Temperature ΔT		°C		
Package		_		

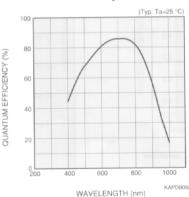
Custom active area types are also available upon request.

To facilitate low-light-level detection using an APD, Hamamatsu provides APD modules that integrate an APD with the operating and signal processing circuits into a compact case. See page 39 for more details

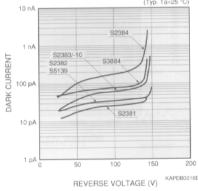
Spectral Response



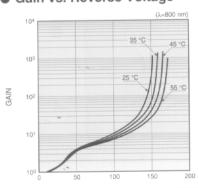
Quantum Efficiency vs. Wavelength



Dark Current vs. Reverse Voltage

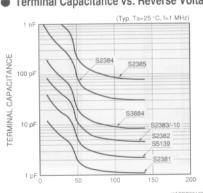


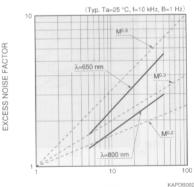
Gain vs. Reverse Voltage



REVERSE VOLTAGE (V)

Terminal Capacitance vs. Reverse Voltage





Excess Noise Factor vs. Gain

^{*2:} The S2383-10 is shielded around the element.

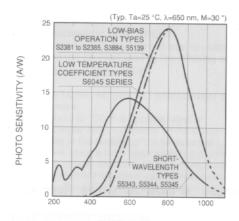
^{*3:} The range that allows muliplication.

(Unless otherwise noted, Typ. Ta=25 °C)

	kdown ge V _{BR}	Tempe- rature	Dark C	urrent *4			Excess *4	Gain		rimum Ratings	
ID=1	ID=100 μA Coefficie (V) of VBF		ID (nA)		fc RL=50 Ω	Capaci- tance Ct	Noise Figure x	М	Operating Temperature Topr	Storage Temperature Tstg	Type No.
Тур.	Max.	(V/°C)	Тур.	Мах.	(MHz)	(pF)	λ=800 nm	λ=800 nm	(°C)	(°C)	
		0.65	0.05	0.5	1000	1.5					S2381
			0.1 1	1	900	3		100		-55 to +125	S2382
					000	- O					S5139
150	200		0.2	2	600	6	0.3		-20 to*+85		S2383
									=0 10 100		S2383-10
			0.5	5	400	10					S3884
			1	10	120	40		60			S2384
			. 3	30	40	95		40			S2385

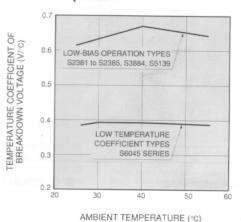
Comparison of Hamamatsu Si APD Characteristics

Spectral Response



WAVELENGTH (nm)

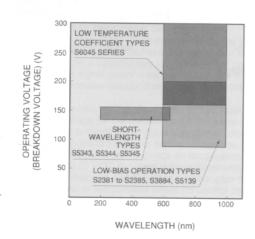
Temerature Coefficient of Breakdown Voltage vs. Ambient Temperature



KAPDB0007ED

KAPDB0031EB

Operating Voltage (Breakdown Voltage) vs. Wavelength



KAPDB0032EB

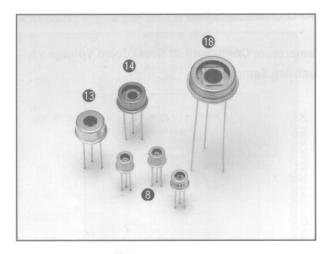
^{*} Measured with a reverse bias voltage that provides a gain of 30 when light at 650 nm wavelength enters the APD.

Si APDs (Low Temperature Coefficient Types, for 800 nm Range)

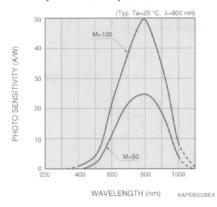
Type No.	Dimensional Outline (P.46, 47)/ Window	Package	Effective *2 Active Area Size	Effective Active Area	Spectral Response Range λ	Peak *3 Sensitivity Wavelength λρ	Photo Sensitivity M=1 λ=800 nm	Quantum Efficiency M=1 λ=800 nm (%)
	Material *1		(mm)	(mm²)	(nm)	(nm)	(A/W)	
S6045-01		B /K TO-18	φ0.2	0.03	400 to 1000		0.5	75
S6045-02	® /K		φ0.5	0.19				
S6045-03			φ1.0	0.78		800		
S6045-04	® /K	TO 5	φ1.5	1.77				
S6045-05	1111111111111	TO-5	ф3.0	7.0				
S6045-06	® /K	TO-8	φ5.0	19.6				

^{*1:} Window material, K: borosilicate glass

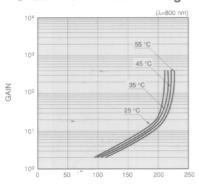
^{*3:} Measured with the gain listed in this specification table



Spectral Response

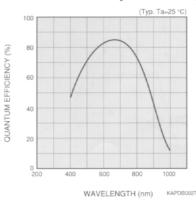


Gain vs. Reverse Voltage

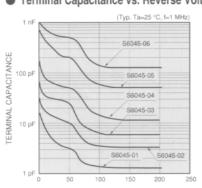


. REVERSE VOLTAGE (V)

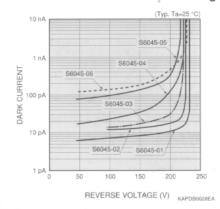
Quantum Efficiency vs. Wavelength



Terminal Capacitance vs. Reverse Voltage



Dark Current vs. Reverse Voltage



^{*2:} The range that allows multiplication.

Voltag	down ge VBR 00 μΑ V)	Tempe- rature Coefficient of VBR	I	urrent *3 D A)	Cut-off *3 Frequency fc RL=50 Ω		Excess *3 Noise Figure x	Gain M	Absolute Max Operating Temperature Topr	Storage Temperature Tstg	Type No.
Тур.	Max.	(V/°C)	Тур.	Max.	(MHz)	(pF)	λ=800 nm	λ=800 nm	(°C)	(°C)	
			0.05	0.5	1000	1.5		0.3	40.50.05	55 4- 1405	S6045-01
			0.1	1	900	3					S6045-02
000	200	0.4	0.2	2	600	6					S6045-03
200	300	0.4	0.5	5	350	12	0.3		-40 to +85	-55 to +125	S6045-04
			1	10	80	50		60			S6045-05
			3	30	35	120		40			S6045-06

Characteristics of Si APDs -

Advantage of the APDs

When using a semiconductor photodetector for low-light-level measurement, it is necessary to take overall performance into account, including not only the semiconductor photodetector characteristics but also the readout circuit (operational amplifier) noise.

When a silicon photodiode is used as a photodetector, the lower detection limit is usually determined by the readout circuit noise because photodiode noise level is very low. This tendency becomes more abvious when the higher frequency of signal to be detected.

This is because the high-speed readout circuit usually exhibits larger noise, resulting in a predominant source of noise in the entire circuit system. In such cases, if the detector itself has an internal gain mechanism and if the output signal from the detector is thus adequately amplified, the readout circuit can be operated so that its noise contribution is minimized to levels equal to one divided by gain (1/10 th to 1/100 th).

In this way, when the lower detection limit is determined by the readout circuit, use of an APD offers the advantage that the lower detection limit can be improved by the APD gain factor to a level 1/10 th to 1/100 th of the lower detection limit obtained with normal photodiodes.

Noise characteristic of Si APDs

When the signal is amplified, the inherent excess noise resulting from current fluctuation in the avalanche multiplication process is also generated. This noise current can be expressed by the following equation:

Shot noise current = √2qlLM²FB

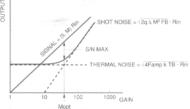
where

F: excess noise factor, M: gain, IL: photocurrent at M=1, q: electron charge, B: bandwidth, x: excess noise index

In the range of M=10 to 100, F is approximated Mx.

Since the excess noise index x depends on the incident light wavelength, the optimum APD must be selected according to the wavelength to be detected.

In PIN photodiodes, using a large load resistance is not practical since it limits the response speed, so the circuit noise is usually dominated by the thermal noise of the photodiode. In contrast, the gain of an APD, which is internally amplified, can be increased until the shot noise reaches the same level as the thermal noise. The APD can therefore offer an improved S/N ratio without impairing the response speed.



Famp: Noise figure of next-stage amplifier
Rin : Input resistance of next-stage amplifier
Boltzmann's constant
Absolute temperature

Spectral response characteristics of APDs

The spectral response characteristics of the APD are almost the same as those of normal photodiodes if a bias voltage is not applied. When a bias voltage is applied, the spectral response curve will change slightly. This means that the gain changes depending on the incident light wavelength. This is because the penetration depth of light into the silicon substrate depends on the wavelength so that the wavelength absorption efficiency in the light absorption region differs depending on the APD structure. It is therefore important to select a suitable APD.

To allow selection of spectral response characteristics, Hamamatsu provides two types of Si APDs: the S2381 series and S6045 series for near infrared detection and the S5343 series for light detection at shorter wavelengths.

Temperature characteristics of gain

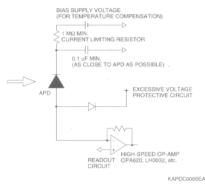
APD gain varies with temperature. For example, when an APD is operated at a constant bias voltage, the gain decreases with increasing temperature. Therefore, in order to obtain a constant output, it is necessary to vary the bias voltage according to the APD temperature or to keep the APD at a constant temperature.

In the S2381 series, the temperature coefficient of the bias voltage is nearly equal to that of the breakdown voltage which is typically 0.65 V/°C at a gain of 100. Hamamatsu also provides the S6045 series APDs which are designed to have an improved temperature coefficient (0.4 V/°C typical).

Connection to peripheral circuits

APDs can be handled in the same manner as normal photodiodes except that a high bias voltage is required. However the following precautions should be taken because APDs have an internal gain mechanism and are operated at a high voltage.

- 1 APDs consume a considerably large amount of power during operation, which is given by the product of the signal power × sensitivity (e.g. 0.5 A/W at 800 nm) × gain × bias voltage. To deal with this, a protective resistor should be added to the bias circuit or a current limiting circuit should be used.
- ② A low-noise readout circuit usually has a high impedance, so if an excessive voltage higher than the supply voltage for the readout circuit flows into the readout circuit, the first stage tends to be damaged. To prevent this, a protective circuit (diode) should be connected so that excessive voltage is diverted to the power supply voltage line.
- 3 As stated above, APD gain depends on temperature. The S2381 series has a typical temperature coefficient of 0.65 V/°C, but there is no problem with using the APD at a gain of around M=30 and 25 °C±3 °C. However, when used at a higher gain or wider temperature range, it is necessary to use some kind of temperature offset (to control the bias voltage according to temperature) or temperature control (to maintain the APD at a constant temperature).
- When detecting low-level light signals, the detection limit can be determined by the shot noise of background light. If background light enters the APD, then the S/N ratio may deteriorate due to the shot noise. As a countermeasure for minimizing background light, use of an optical filter, improving laser modulation or restricting the field of view is necessary.

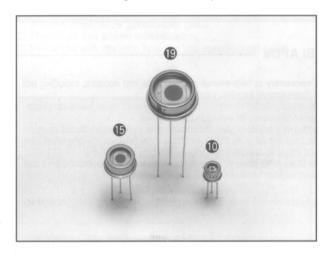


Si APDs (Short-wavelength Types)

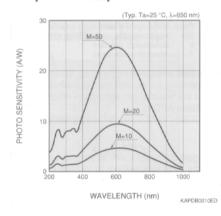
Type No.	Dimensional Outline (P.47, 48)/ Window Material *1	Package	Effective *2 Active Area Size (mm)	Effective Active Area (mm²)	Spectral Response Range λ (nm)	Peak *3 Sensitivity Wavelength λp (nm)	Photo Sensitivity M=1 λ=620 nm (A/W)	Quantum Efficiency M=1 λ=620 nm (%)	
S5343	10 /U	TO-18	φ1.0	0.78					
S5344	® /U	TO-5	φ3.0	7.0	200 to 1000	620	0.42	80	
S5345	® /U	TO-8	φ5.0	19.6					

^{*1:} Window material, U: UV glass window

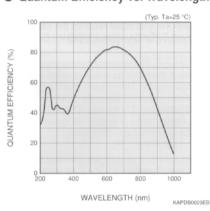
^{*3:} Measured with the gain listed in this specification table



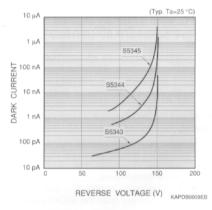
Spectral Response



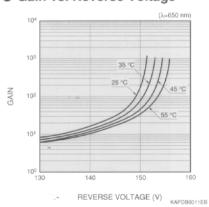
Quantum Efficiency vs. Wavelength



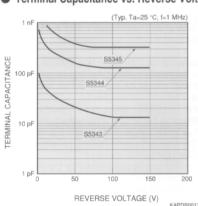
Dark Current vs. Reverse Voltage



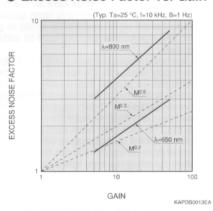
Gain vs. Reverse Voltage



Terminal Capacitance vs. Reverse Voltage



Excess Noise Factor vs. Gain



^{*2:} The range that allows multiplication.

(Unless otherwise noted, Typ. Ta=25 °C)

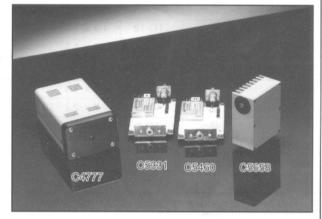
Voltaç I⊫10	kdown ge VBR 00 μΑ V)	Tempe- rature Coefficient of VBR		urrent *3 D A)	Cut-off *3 Frequency fc RL=50 Ω		Excess *3 Noise Figure x	Gain	Absolute Max Operating Temperature Topr	Storage Temperature Tstg	Type No.
Тур.	Max.	(V/°C)	Тур.	Max.	(MHz)	(pF)	λ=650 nm	λ=650 nm	(°C)	(°C)	
			1	10	250	15	-				S5343
150	200	0.14	20	100	25	120	0.28	50	-20 to +60	-55 to +100	S5344
			300	1000	8	320					S5345

- APD Modules -

The APD modules are high-sensitivity, high-speed O/E converters, consisting of an APD, low-noise amplifier, and bias power supply, integrated into a compact case. These modules enable light detection with an excellent S/N ratio several ten times higher than that obtained with PIN photodiodes. These modules are ideally suited for evaluation and production of light detection systems using APDs.

FEATURES

- High sensitivity, high S/N ratio, high stability
- Easy handling
- Compact and lightweight
- Low cost
- Suitable for evaluation of APD



Feature/Application	Type No.	,,		Frequency	Photoelectric Sensitivity	Minimum Detection	Temperature Stability of Gain	Supply Voltage
		(mm)	Low	High	(V/W)	Limit	(25 °C±10 °C)	J
Standard Types (for NIR) *4								
Peak sensitivity wavelength: 800 nm	C5331	φ1.5	4 kHz	100 MHz	4.50 × 10 ⁴ *5	3 nWr.m.s *5		
Evaluation of APD	C5331-01	φ0.2	4 kHz	100 MHz	$7.50 \times 10^{4*5}$	3 nWr.m.s *5	757	
· Spatial light transmission	C5331-02	φ0.5	4 kHz	100 MHz	7.50 × 10 ⁴ *5	3 nWr.m.s *5	±2.5 %	+5 V
· Optical rangefinder	C5331-03	φ1.0	4 kHz	100 MHz	6.75 × 10 ⁴ *5	3 nWr.m.s *5	±2.5 %	+5 V
· Optical communication	C5331-04	ф3.0	4 kHz	80 MHz	2.30 × 10 ⁴ *5	4 nWr.m.s *5		
· Laser Radar	C5331-05	φ5.0	4 kHz	50 MHz	0.75 × 10 ⁴ 5	5 nWr.m.s *5		
Standard Types (for short way	elength) *4							
Peak sensitivity wavelength: 620 nm	C5331-11	φ1.0	4 kHz	100 MHz	2.70 × 10 ⁴ 6	5 nWr.m.s *6		
· Film scanner	C5331-12	ф3.0	4 kHz	40 MHz	1.40 × 10 ⁴ 6	11 nWr.m.s *6	±2.5 %	+5 V
· Laser monitoring	C5331-13	φ5.0	4 kHz	20 MHz	0.77 × 10 ⁴ 6	10 nWr.m.s ^{*6}		
High-sensitivity Types								
Low-light-level detection	C5460	φ1.5	DC	10 MHz	1.50 × 10 ⁶ *5	800 pWr.m.s *5		
Bar code reader							±2.5 %	±12 V
Fluorescence measurement	C5460-01	φ3.0	DC	100 kHz	1.50 × 108*5	5 pWr.m.s *5		
Particle counter								
High-speed Type								
Detection of high-speed response light	C5658	φ0.5	1 MHz	1 GHz	2.50×10^{5}	16 nWr.m.s *7	±5.0 %	+12 V
OTDR, Optical communication								
TE-cooled Type	-							
Stable detection of light	C4777	φ0.5	10 kHz	100 MHz	$5.00 \times 10^{5^{+7}}$	0.8 nWr.m.s *7	±1.0 %	±15 V
Scientific measurement *4: Integrated optical fiber connector	C4777-01	ф3.0	DC	5 kHz	1.25 × 10 ^{9*8}	0.2 pWr.m.s *8		+5 V

- *5: M=30, λ=800 nm
- *6: M=30, λ=620 nm
- *7: M=100, λ=800 nm *8: M=50, λ=800 nm